

RECOMMENDED P.C.B LAYOUT

## ROHS COMPLIANT

DESCRIPTION: 0.085 RIBBON - DIP SOLDER

区

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF NOTCOMP AND SHALL NOT BE REPRODUCED, COPIED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS WITHOUT WRITTEN PERMISSION.

DRAWN:
WAYNE ROBBINS
DATE:
09/15/2005

SPECIFICATIONS:

ELECTRICAL:

CURRENT RATING:

INSULATION RESISTANCE:

DIELECTRIC WITHSTANDING VOLTAGE: CONTACT RESISTANCE:

OPERATING TEMPERATURE:

MATERIALS:

INSULATION: PBT, UL 94 V-O RATED
CONTACTS: PHOSPHOR BRONZE
CONTACT PLATING: GOLD FLASH IN MATING AREA

BRIGHT TIN IN SOLDER AREA

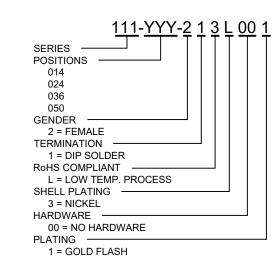
1 AMPS

30 m $\Omega$  MAX.

-55°C TO +105°C

1,000 MΩ MIN. @ 500 VDC 1,000 VAC FOR 1 MINUTE

SHELL: STEEL, NICKEL PLATED



UNITS = mm

DO NOT SCALE FROM DRAWING

NorComp

SCALE: SHEET OF REV 10 10 111-YYY-213L001

